



30V/112A N-Channel Advanced Power MOSFET

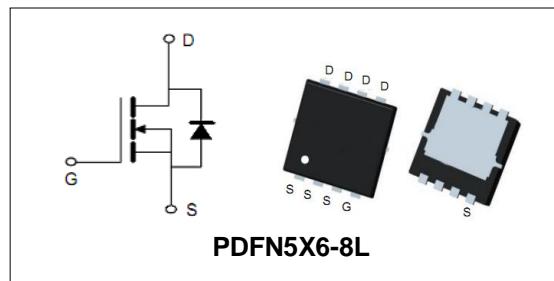
Features

- Low RDS(on)@4.5V Logic
- 5v Logic Level control
- PDFN5X6 SMD Package

BVDSS	30	V
ID	112	A
RDS(on)@VGS=10V	1.8	mΩ
RDS(on)@VGS=4.5V	3.2	mΩ

Applications

- High Side Load Switch
- Battery Switch
- Optimized for Power Management Applications for Portable Products, such as Aeromodelling, Power bank, Brushless motor, Main board , and Others

**Order Information**

Product	Package	Marking	Reel Size	Reel	Carton
PTN03N120	PDFN5X6-8L	PTN03N120	13inch	5000PCS	50000PCS

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common Ratings (TC=25°C Unless Otherwise Noted)				
V _{(BR)DSS}	Drain-Source Breakdown Voltage	30	V	
V _{GS}	Gate-Source Voltage	±20	V	
T _J	Maximum Junction Temperature	150	°C	
T _{STG}	Storage Temperature Range	-55 to 150	°C	
I _S	Diode Continuous Forward Current	TC =25°C	112	A

Mounted on Large Heat Sink

E _{AS}	Avalanche Energy, Single Pulsed (Note1)	144	mJ	
I _{DM}	Pulse Drain Current Tested (Silicon Limit) (Note2)	TC =25°C	448	A
I _D	Continuous Drain current	TC =25°C	112	A
P _D	Maximum Power Dissipation	TC =25°C	56	W
R _{θJC}	Thermal Resistance Junction-to-Case (Note3)		2.23	°C/W

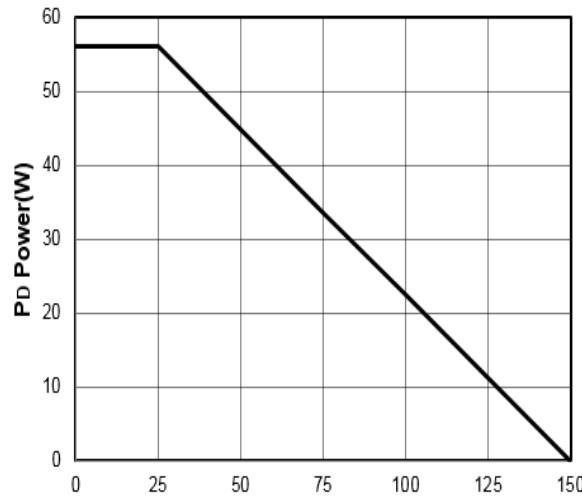
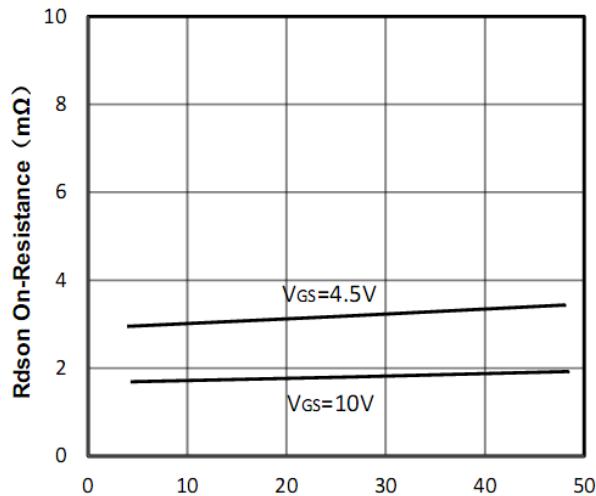
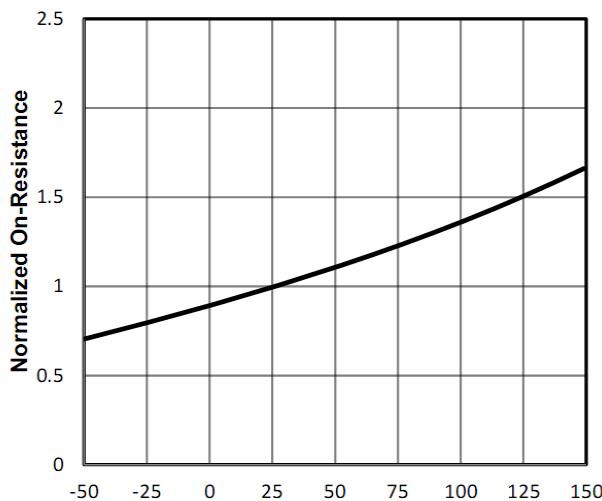
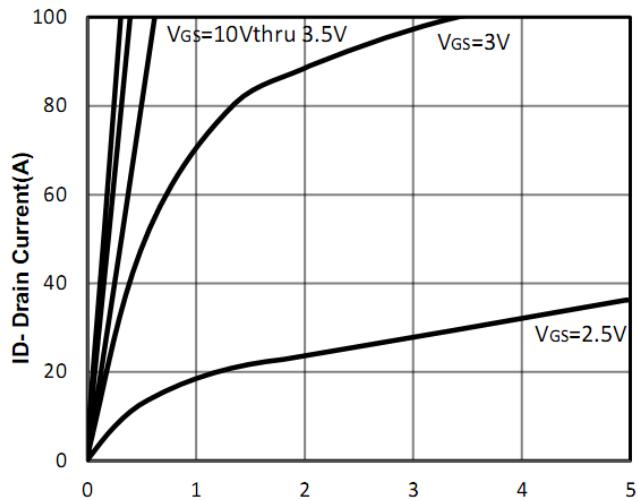
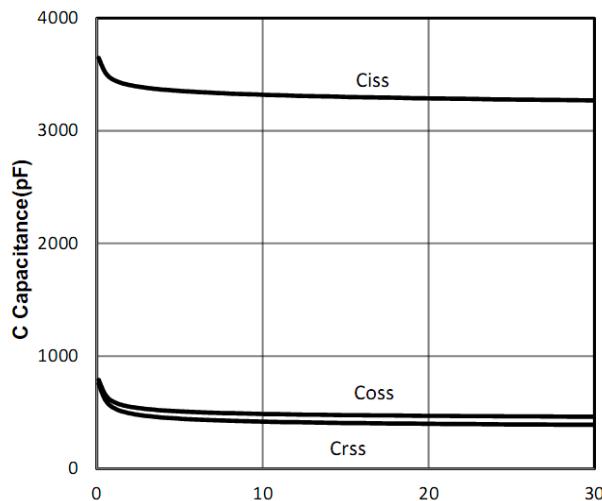
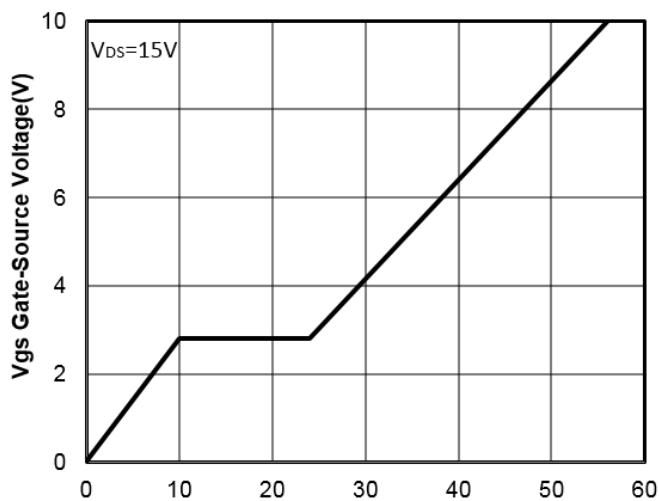


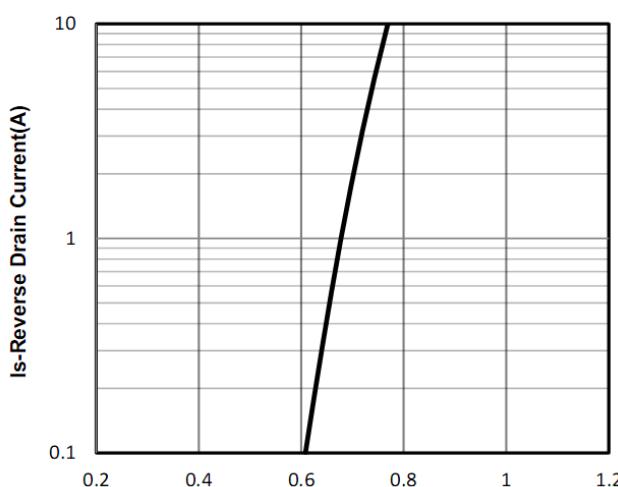
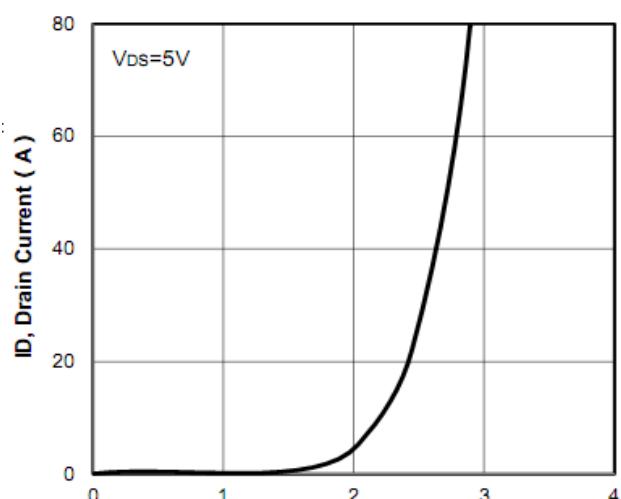
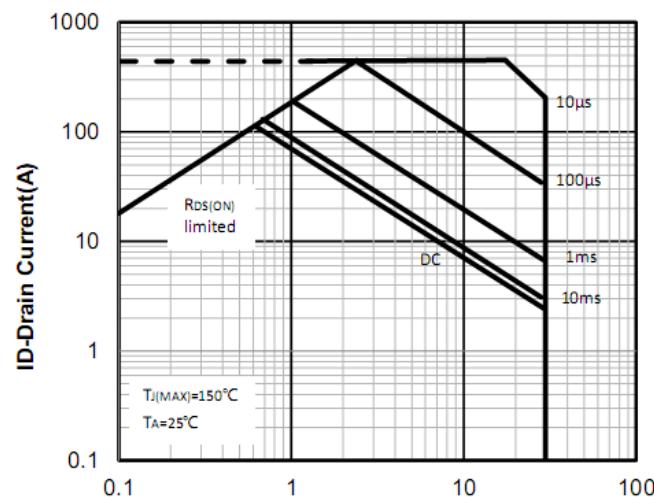
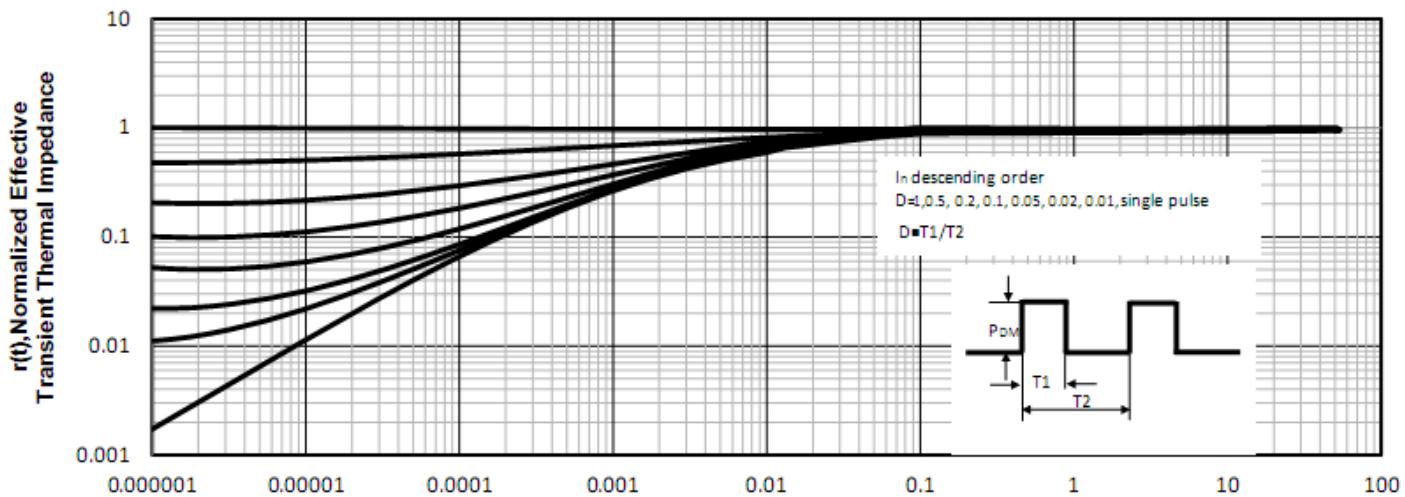
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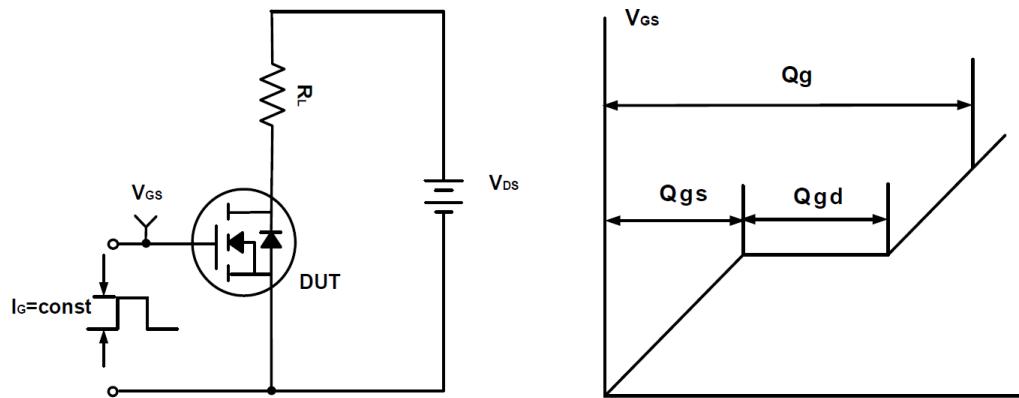
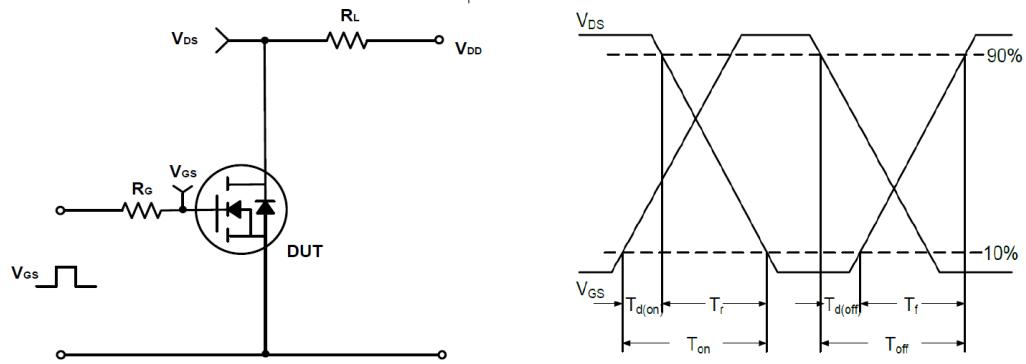
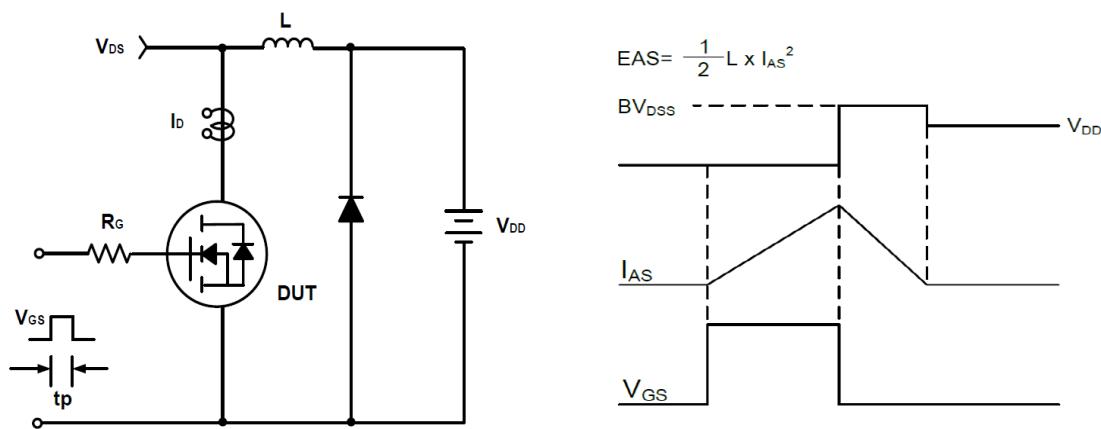
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$V_{(BR)DSS}$	Drain- Source Breakdown Voltage	$VGS=0V$ $ID=250\mu A$	30	--	--	V
I_{DSS}	Zero Gate Voltage Drain current	$VDS=24V$, $VGS=0V$	--	--	1	μA
I_{GSS}	Gate-Body Leakage Current	$VGS=\pm 20V$, $VDS=0V$	--	--	± 100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$VDS=VGS$, $ID=250\mu A$	1.0	1.5	2.5	V
$R_{DS(ON)}$	Drain-Source On-State Resistance (Note4)	$VGS=10V$, $ID=20A$	--	1.8	2.8	$m\Omega$
		$VGS=4.5V$, $ID=10A$	--	3.2	5	$m\Omega$
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated) (Note5)						
C_{iss}	Input Capacitance	$VDS=15V$, $VGS=0V$, $F=1MHz$	--	3380	--	pF
C_{oss}	Output Capacitance		--	474	--	pF
C_{rss}	Reverse Transfer Capacitance		--	427	--	pF
Q_g	Total Gate Charge	$VDS=15V$, $ID=30A$, $VGS=10V$	--	56	--	nC
Q_{gs}	Gate-Source Charge		--	10	--	nC
Q_{gd}	Gate-Drain Charge		--	14	--	nC
Switching Characteristics (Note5)						
$t_{d(on)}$	Turn-on Delay Time	$VDS=15V$, $ID=30A$, $RG=3\Omega$, $VGS=10V$	--	25	--	nS
t_r	Turn-on Rise Time		--	23	--	nS
$t_{d(off)}$	Turn-off Delay Time		--	73	--	nS
t_f	Turn-off Fall Time		--	22	--	nS
Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated)						
V_{SD}	Forward on voltage	$IS=30A$, $VGS=0V$	--	0.8	1.2	V
t_{rr}	Reverse Recovery Time	$Tj=25^\circ C$, $ISD=20A$, $VGS=0V$, $di/dt=100A/\mu s$	--	30	--	nS
Q_{rr}	Reverse Recovery Charge		--	15	--	nC

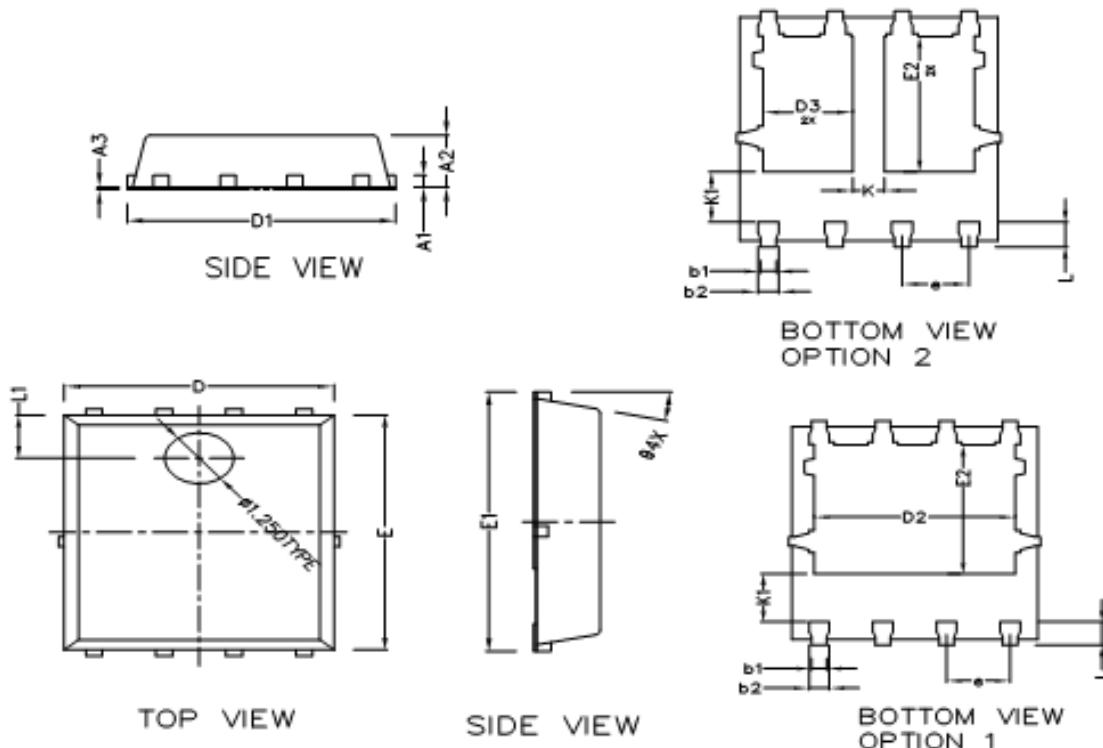
Note:

1. Limited by $TJmax$, starting $TJ = 25^\circ C$, $RG = 4.5\Omega$, $VD = 15V$, $VGS = 10V$. Part not recommended for use above this value.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. Surface Mounted on FR4 Board, $t \leq 10$ sec.
4. Pulse Test: pulse width ≤ 300 us, duty cycle $\leq 2\%$.
5. Guaranteed by design, not subject to production testing.

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Typical Characteristics

Figure1: TJ Junction Temperature (°C)

Figure2: Id Drain Current (A)

Figure3: TJ Junction Temperature (°C)

Figure4: V_{DS} Drain-Source Voltage (V)

Figure5: V_{DS} Drain-Source Voltage (V)

Figure6: Q_g Gate Charge (nC)

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Figure7: Vsd Source-Drain Voltage (V)

Figure8: Vgs Gate-Source Voltage (V)

Figure9: VDS Drain -Source Voltage (V)

Figure10: Square Wave Pulse Duration (sec)

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Test Circuit and Waveform:

Figure A Gate Charge Test Circuit & Waveforms

Figure B Switching Test Circuit & Waveforms

Figure C Unclamped Inductive Switching Circuit & Waveforms

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PDFN5X6-8L Package Outline Dimensions (Units: mm)


COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A1		0.254 BSC	
A2	1.000	1.100	1.200
A3	0.005	—	0.020
b1	0.250	0.300	0.350
b2	0.350	0.400	0.450
D	4.800	4.900	5.000
D1	5.000	5.100	5.200
D2	3.910	4.010	4.110
D3	1.605	1.705	1.805
E	5.650	5.750	5.850
E1	5.950	6.050	6.150
E2	3.375	3.475	3.575
e	1.270 TYPE		
L	0.530	0.630	0.730
L1	1.00REF		
θ	13° TYPE		
K	0.600 REF		
K1	1.235 REF		